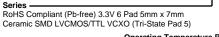


## EV32C3 A 3 A 1 -24.576M TR Packaging Options Tape & Reel



Operating Temperature Range 0°C to +70°C

Absolute Pull Range

±50ppm Minimum

Nominal Frequency 24.576MHz • Duty Cycle 50 ±5(%) Typical, 50 ±10(%) Maximum

## **ELECTRICAL SPECIFICATIONS**

| Nominal Frequency                     | 24.576MHz                                                                                                                                                                                                                                    |
|---------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Frequency Tolerance/Stability         | ±50ppm Maximum (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, Shock, and Vibration.)                                      |
| Aging at 25°C                         | ±2ppm/first year Typical, ±10ppm/10 years Maximum                                                                                                                                                                                            |
| Operating Temperature Range           | 0°C to +70°C                                                                                                                                                                                                                                 |
| Supply Voltage                        | 3.3Vdc ±10%                                                                                                                                                                                                                                  |
| Input Current                         | 15mA Maximum                                                                                                                                                                                                                                 |
| Output Voltage Logic High (Voh)       | 90% of Vdd Minimum (IOH = -4mA)                                                                                                                                                                                                              |
| Output Voltage Logic Low (Vol)        | 10% of Vdd Minimum (IOL = +4mA)                                                                                                                                                                                                              |
| Rise/Fall Time                        | 5nSec Maximum (Measured at 20% to 80% of Waveform)                                                                                                                                                                                           |
| Duty Cycle                            | 50 $\pm$ 5(%) Typical, 50 $\pm$ 10(%) Maximum (Measured at 50% of Waveform)                                                                                                                                                                  |
| Load Drive Capability                 | 15pF LVCMOS Load Maximum                                                                                                                                                                                                                     |
| Output Logic Type                     | CMOS                                                                                                                                                                                                                                         |
| Absolute Pull Range                   | ±50ppm Minimum (Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, Shock, Vibration, and Aging over the Control Voltage (Vc).) |
| Control Voltage                       | 0.3Vdc to 3.0Vdc (Test Condition for APR)                                                                                                                                                                                                    |
| Control Voltage Range                 | 0.0Vdc to Vdd                                                                                                                                                                                                                                |
| Linearity                             | 10% Typical, 20% Maximum                                                                                                                                                                                                                     |
| Transfer Function                     | Positive Tranfer Characteristic                                                                                                                                                                                                              |
| Modulation Bandwidth                  | 10kHz Minimum (Measured at -3dB, Vc = 1.65Vdc)                                                                                                                                                                                               |
| Input Impedance                       | 50kOhms Minimum                                                                                                                                                                                                                              |
| Input Leakage Current                 | 10µA Maximum                                                                                                                                                                                                                                 |
| Phase Noise                           | -70dBc/Hz at offset of 10Hz, -100dBc/Hz at offset of 100Hz, -130dBc/Hz at offset of 1kHz, -147dBc/Hz at offset of 10kHz, -152dBc/Hz at offset of 100kHz, and -155dBc/Hz at offset of 1MHz (Typical Values at Fo = 27MHz)                     |
| Tri-State Input Voltage (Vih and Vil) | +0.9Vdd Minimum to Enable Output; +0.1Vdd Maximum to Disable Output (High Impedance); No Connect to Enable Output.                                                                                                                           |
| RMS Phase Jitter                      | 1pSec Maximum (Fj = 12kHz to 20MHz)                                                                                                                                                                                                          |
| Start Up Time                         | 10mSec Maximum                                                                                                                                                                                                                               |
| Storage Temperature Range             | -55°C to +125°C                                                                                                                                                                                                                              |

### **ENVIRONMENTAL & MECHANICAL SPECIFICATIONS**

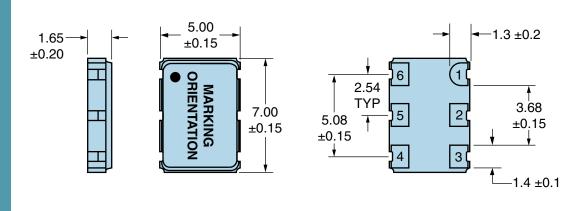
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
|------------------------------|-----------------------------------------------|
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A         |
| Flammability                 | UL94-V0                                       |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C         |
| Mechanical Shock             | MIL-STD-883, Method 2002, Condition B         |
| Moisture Resistance          | MIL-STD-883, Method 1004                      |
| Moisture Sensitivity         | J-STD-020, MSL 1                              |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K          |
| Resistance to Solvents       | MIL-STD-202, Method 215                       |
| Solderability                | MIL-STD-883, Method 2003                      |



### **ENVIRONMENTAL & MECHANICAL SPECIFICATIONS**

| Temperature Cycling | MIL-STD-883, Method 1010, Condition B |
|---------------------|---------------------------------------|
| Vibration           | MIL-STD-883, Method 2007, Condition A |

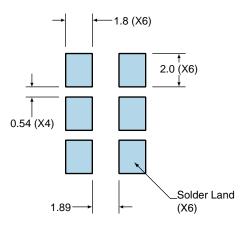
### **MECHANICAL DIMENSIONS (all dimensions in millimeters)**



| PIN       | CONNECTION          |
|-----------|---------------------|
| 1         | Control Voltage     |
| 2         | No Connect          |
| 3         | Case Ground         |
| 4         | Output              |
| 5         | Tri-State           |
| 6         | Supply Voltage      |
|           |                     |
| LINE      | MARKING             |
| LINE<br>1 | MARKING<br>ECLIPTEK |
|           |                     |

#### Suggested Solder Pad Layout

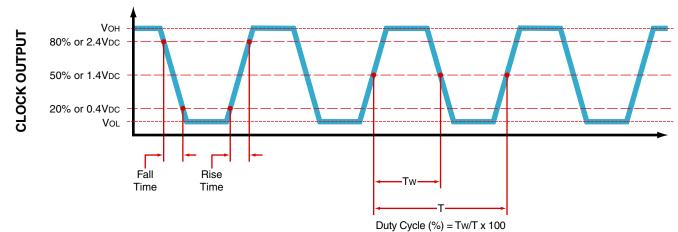
All Dimensions in Millimeters



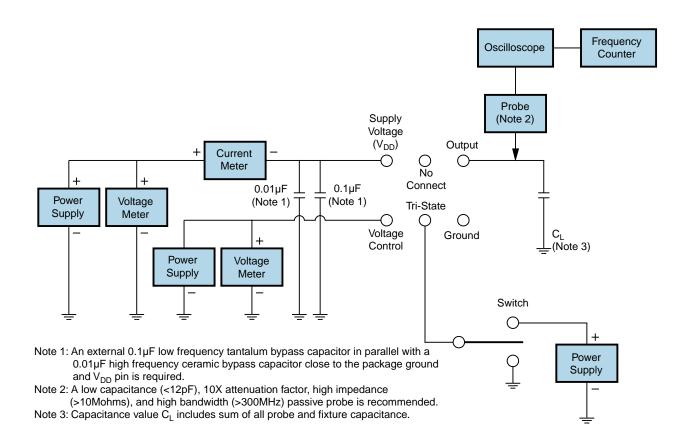
All Tolerances are ±0.1



#### **OUTPUT WAVEFORM**

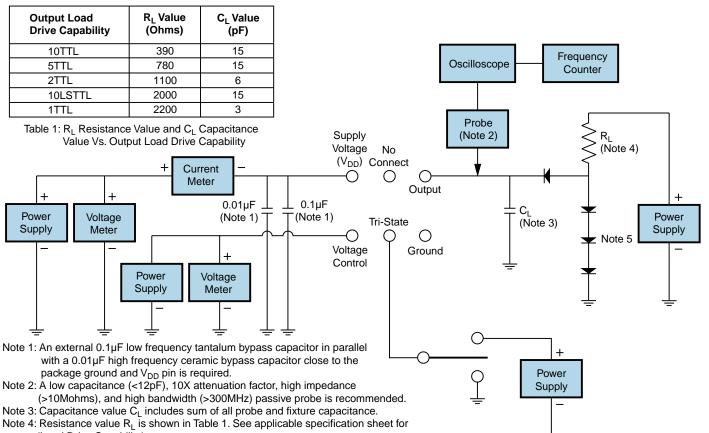


#### **Test Circuit for CMOS Output**





#### Test Circuit for TTL Output



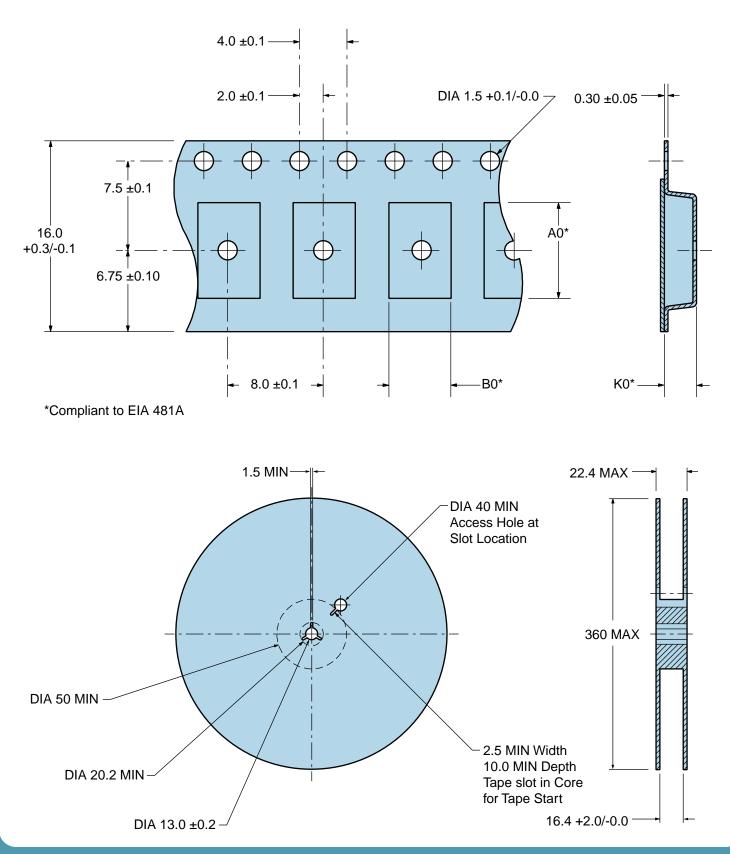
<sup>&#</sup>x27;Load Drive Capability'.

Note 5: All diodes are MMBD7000, MMBD914, or equivalent.



## **Tape & Reel Dimensions**

Quantity Per Reel: 1,000 units



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## **Recommended Solder Reflow Methods**

EV32C3A3A1-24.576M TR



### **High Temperature Infrared/Convection**

| $T_s$ MAX to $T_L$ (Ramp-up Rate)                | 3°C/second Maximum                   |
|--------------------------------------------------|--------------------------------------|
| Preheat                                          |                                      |
| - Temperature Minimum (T <sub>s</sub> MIN)       | 150°C                                |
| - Temperature Typical (T <sub>s</sub> TYP)       | 175°C                                |
| - Temperature Maximum (T <sub>s</sub> MAX)       | 200°C                                |
| - Time (t <sub>s</sub> MIN)                      | 60 - 180 Seconds                     |
| Ramp-up Rate (T <sub>L</sub> to T <sub>P</sub> ) | 3°C/second Maximum                   |
| Time Maintained Above:                           |                                      |
| - Temperature (T∟)                               | 217°C                                |
| - Time (t∟)                                      | 60 - 150 Seconds                     |
| Peak Temperature (T <sub>P</sub> )               | 260°C Maximum for 10 Seconds Maximum |
| Target Peak Temperature (T <sub>P</sub> Target)  | 250°C +0/-5°C                        |
| Time within 5°C of actual peak (t <sub>P</sub> ) | 20 - 40 seconds                      |
| Ramp-down Rate                                   | 6°C/second Maximum                   |
| Time 25°C to Peak Temperature (t)                | 8 minutes Maximum                    |
| Moisture Sensitivity Level                       | Level 1                              |
|                                                  |                                      |



## **Recommended Solder Reflow Methods**

EV32C3A3A1-24.576M TR



### Low Temperature Infrared/Convection 240°C

| T <sub>s</sub> MAX to T <sub>L</sub> (Ramp-up Rate) | 5°C/second Maximum                                     |
|-----------------------------------------------------|--------------------------------------------------------|
| Preheat                                             |                                                        |
| - Temperature Minimum (Ts MIN)                      | N/A                                                    |
| - Temperature Typical (T <sub>s</sub> TYP)          | 150°C                                                  |
| - Temperature Maximum (T <sub>s</sub> MAX)          | N/A                                                    |
| - Time (t <sub>s</sub> MIN)                         | 60 - 120 Seconds                                       |
| Ramp-up Rate (T⊾ to T <sub>P</sub> )                | 5°C/second Maximum                                     |
| Time Maintained Above:                              |                                                        |
| - Temperature (T∟)                                  | 150°C                                                  |
| - Time (t∟)                                         | 200 Seconds Maximum                                    |
| Peak Temperature (T <sub>P</sub> )                  | 240°C Maximum                                          |
| Target Peak Temperature (T <sub>P</sub> Target)     | 240°C Maximum 1 Time / 230°C Maximum 2 Times           |
| Time within 5°C of actual peak (t <sub>p</sub> )    | 10 seconds Maximum 2 Times / 80 seconds Maximum 1 Time |
| Ramp-down Rate                                      | 5°C/second Maximum                                     |
| Time 25°C to Peak Temperature (t)                   | N/A                                                    |
| Moisture Sensitivity Level                          | Level 1                                                |

#### Low Temperature Manual Soldering

185°C Maximum for 10 seconds Maximum, 2 times Maximum.

#### **High Temperature Manual Soldering**

260°C Maximum for 5 seconds Maximum, 2 times Maximum.